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September 22, 2011

DS90UR903Q/DS90UR904Q

10 - 43MHz 18 Bit Color FPD-Link II Serializer and Deserializer

General Description

The DS90UR903Q/DS90UR904Q chipset offers a FPD-Link II interface with a high-speed forward channel for data transmission over a single differential pair. The Serializer/ Deserializer pair is targeted for direct connections between graphics host controller and displays modules. This chipset is ideally suited for driving video data to displays requiring 18-bit color depth (RGB666 + HS, VS, and DE). The serializer converts 21 bit data over a single high-speed serial stream. This single serial stream simplifies transferring a wide data bus over PCB traces and cable by eliminating the skew problems between parallel data and clock paths. This significantly saves system cost by narrowing data paths that in turn reduce PCB layers, cable width, and connector size and pins.

The Deserializer inputs provide equalization control to compensate for loss from the media over longer distances. Internal DC balanced encoding/decoding is used to support AC-Coupled interconnects.

The Serializer is offered in a 40-pin lead in LLP and Deserializer is offered in a 48-pin LLP packages.
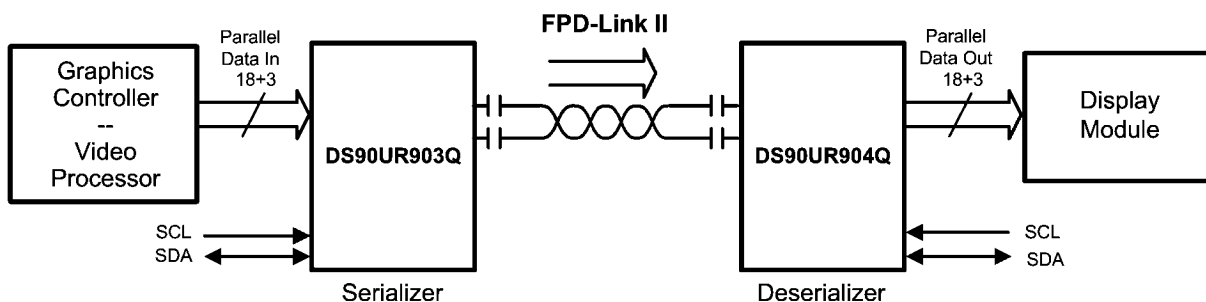
Features

■ 10 MHz to 43 MHz input PCLK support
■ 210 Mbps to 903 Mbps data throughput
■ Single differential pair interconnect
■ Embedded clock with DC Balanced coding to support AC-coupled interconnects

■ Capable to drive up to 10 meters shielded twisted-pair
■ I²C compatible serial interface for device configuration
■ Single hardware device addressing pin
■ LOCK output reporting pin to validate link integrity
■ Integrated termination resistors
■ 1.8V- or 3.3V-compatible parallel bus interface
■ Single power supply at 1.8V
■ ISO 10605 ESD and IEC 61000-4-2 ESD compliant
■ Automotive grade product: AEC-Q100 Grade 2 qualified
■ Temperature range −40°C to +105°C
■ No reference clock required on Deserializer
■ Programmable Receive Equalization
■ EMI/EMC Mitigation
  — DES Programmable Spread Spectrum (SSCG) outputs
  — DES Receiver staggered outputs

Applications

■ Automotive Display Systems
  — Central Information Displays
  — Navigation Displays
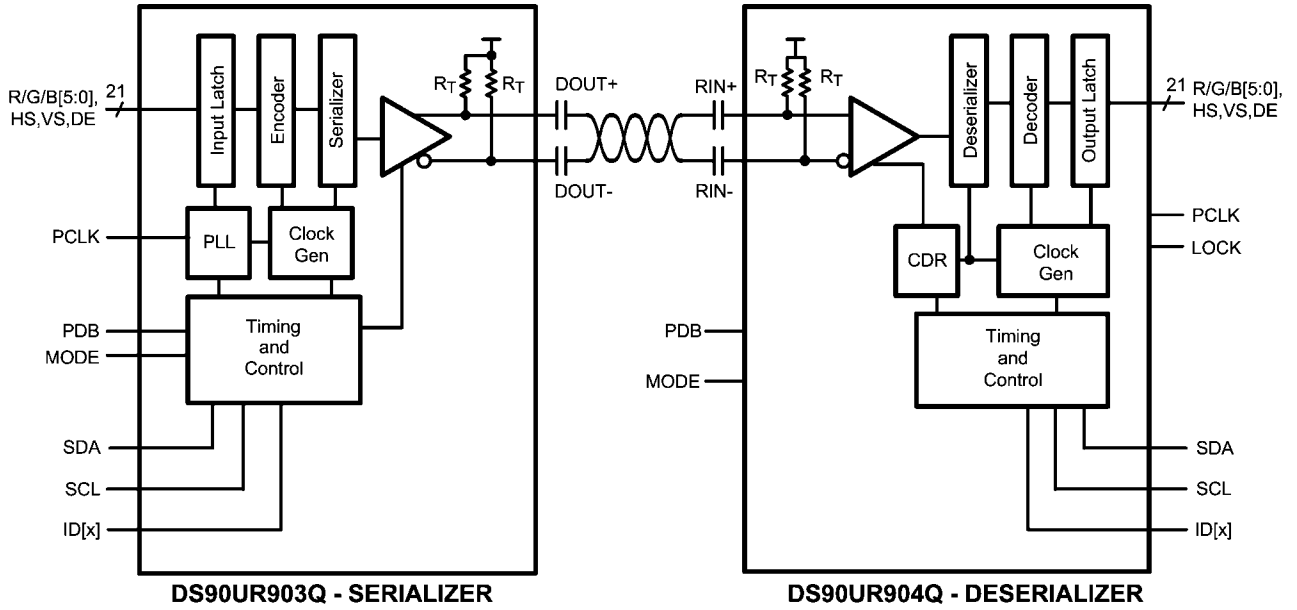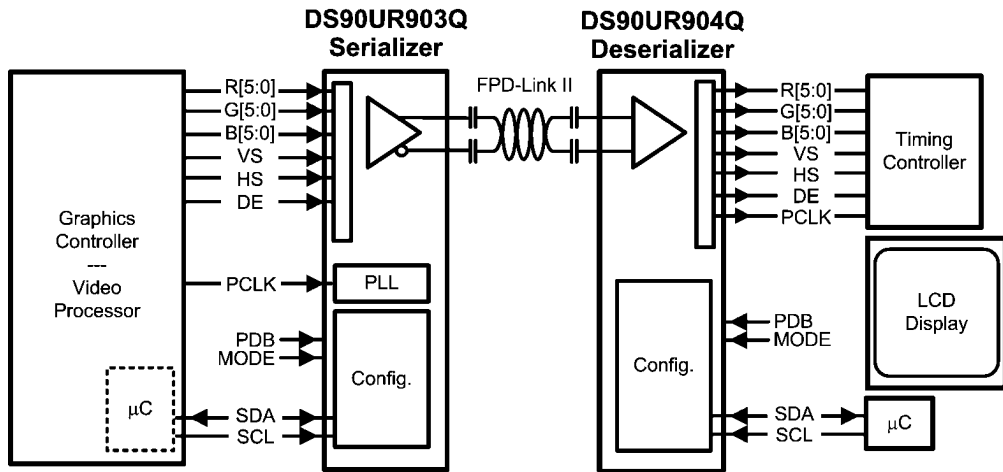 — Rear Seat Entertainment

Typical Application Diagram

FIGURE 1. Typical Application Circuit

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Block Diagrams

FIGURE 2. Block Diagram

FIGURE 3. Application Block Diagram

Ordering Information

NSID	Package Description	Quantity	SPEC	Package ID
DS90UR903QSQE	40-pin LLP, 6.0 X 6.0 X 0.8 mm, 0.5 mm pitch	250	NOPB	SQA40A
DS90UR903QSQ	40-pin LLP, 6.0 X 6.0 X 0.8 mm, 0.5 mm pitch	1000	NOPB	SQA40A
DS90UR903QSQX	40-pin LLP, 6.0 X 6.0 X 0.8 mm, 0.5 mm pitch	4500	NOPB	SQA40A
DS90UR904QSQE	48-pin LLP, 7.0 X 7.0 X 0.8 mm, 0.5 mm pitch	250	NOPB	SQA48A
DS90UR904QSQ	48-pin LLP, 7.0 X 7.0 X 0.8 mm, 0.5 mm pitch	1000	NOPB	SQA48A
DS90UR904QSQX	48-pin LLP, 7.0 X 7.0 X 0.8 mm, 0.5 mm pitch	4500	NOPB	SQA48A

Note: Automotive Grade (Q) product incorporates enhanced manufacturing and support processes for the automotive market, including defect detection methodologies. Reliability qualification is compliant with the requirements and temperature grades defined in the AEC Q100 standard. Automotive Grade products are identified with the letter Q. For more information go to http://www.national.com/automotive.

DS90UR903Q Pin Diagram
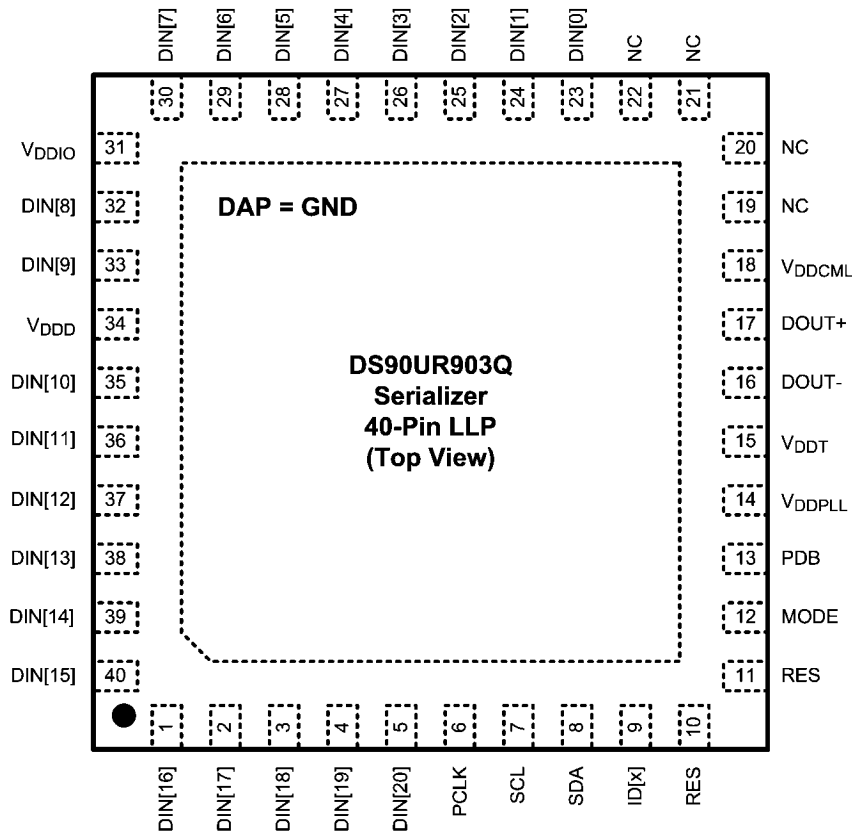
Serializer - DS90UR903Q — Top View

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DS90UR903Q Serializer Pin Descriptions

Pin Name	Pin No.	I/O, Type	Description
LVCMOS PARALLEL INTERFACE			
DIN[20:0]	5, 4, 3, 2, 1, 40, 39, 38, 37, 36, 35, 33, 32, 30, 29, 28, 27, 26, 25, 24, 23	Inputs, LVCMOS w/ pull down	Parallel data inputs.
PCLK	6	Input, LVCMOS w/ pull down	Pixel Clock Input Pin. Strobe edge set by TRFB control register.
SERIAL CONTROL BUS - I²C COMPATIBLE			
SCL	7	Input, Open Drain	Clock line for the serial control bus communication. SCL requires an external pull-up resistor to V_{DDIO}.
SDA	8	Input/Output, Open Drain	Data line for the serial control bus communication. SDA requires an external pull-up resistor to V_{DDIO}.
MODE	12	Input, LVCMOS w/ pull down	I²C Mode select. MODE = H,- **REQUIRED**. The MODE pin must be set HIGH to allow I²C configuration of the serializer.
ID[x]	9	Input, analog	Device ID Address Select. Resistor to Ground and 10 kΩ pull-up to 1.8V rail. See *Table 3*
CONTROL AND CONFIGURATION			
PDB	13	Input, LVCMOS w/ pull down	Power down Mode Input Pin. PDB = H, Serializer is enabled and is ON. PDB = L, Serializer is in Power Down mode. When the Serializer is in Power Down, the PLL is shutdown, and IDD is minimized. Programmed control register data are NOT retained and reset to default values
RES	10, 11	Input, LVCMOS w/ pull down	Reserved. This pin MUST be tied LOW.
NC	22, 21, 20, 19		No Connect
FPD-LINK II INTERFACE			
DOUT+	17	Output, CML	Non-inverting differential output. The interconnect must be AC Coupled with a 100 nF capacitor.
DOUT-	16	Output, CML	Inverting differential output. The interconnect must be AC Coupled with a 100 nF capacitor.
POWER AND GROUND			
VDDPLL	14	Power, Analog	PLL Power, 1.8V ±5%
VDDT	15	Power, Analog	Tx Analog Power, 1.8V ±5%
VDDCML	18	Power, Analog	CML Power, 1.8V ±5%
VDDD	34	Power, Digital	Digital Power, 1.8V ±5%
VDDIO	31	Power, Digital	Power for I/O stage. The single-ended inputs and SDA, SCL are powered from V_{DDIO}. V_{DDIO} can be connected to a 1.8V ±5% or 3.3V ±10%
VSS	DAP	Ground, DAP	DAP must be grounded. DAP is the large metal contact at the bottom side, located at the center of the LLP package. Connected to the ground plane (GND) with at least 16 vias.

DS90UR904Q Pin Diagram
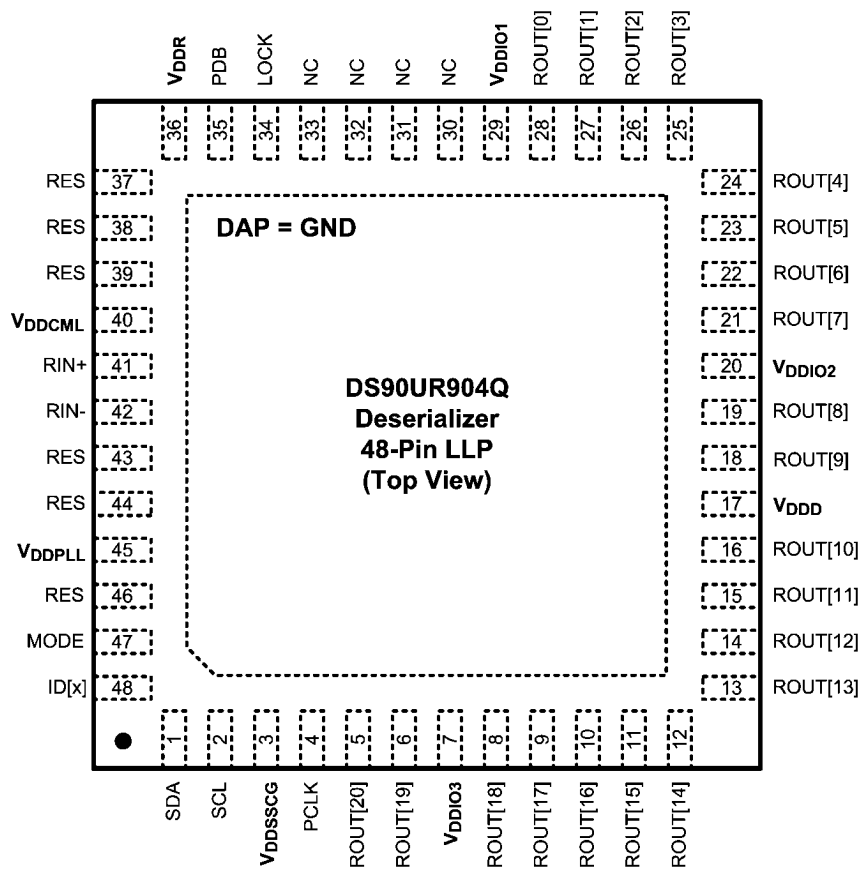
Deserializer - DS90UR904Q — Top View

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DS90UR904Q Deserializer Pin Descriptions

Pin Name	Pin No.	I/O, Type	Description
LVCMOS PARALLEL INTERFACE			
ROUT[20:0]	5, 6, 8, 9, 10, 11, 12, 13, 14, 15, 16, 18, 19, 21, 22, 23, 24, 25, 26, 27, 28	Outputs, LVCMOS	Parallel data outputs.
PCLK	4	Output, LVCMOS	Pixel Clock Output Pin. Strobe edge set by RRFB control register.
SERIAL CONTROL BUS - I²C COMPATIBLE			
SCL	2	Input, Open Drain	Clock line for the serial control bus communication SCL requires an external pull-up resistor to V_{DDIO}.
SDA	1	Input/Output, Open Drain	Data line for the serial control bus communication SDA requires an external pull-up resistor to V_{DDIO}.
MODE	47	Input, LVCMOS w/ pull up	I²C Mode select MODE = H -**REQUIRED**. The MODE pin must be set HIGH to allow I²C configuration of the deserializer.
ID[x]	48	Input, analog	Device ID Address Select Resistor to Ground and 10 kΩ pull-up to 1.8V rail. See *Table 4*
CONTROL AND CONFIGURATION			
PDB	35	Input, LVCMOS w/ pull down	Power down Mode Input Pin. PDB = H, Deserializer is enabled and is ON. PDB = L, Deserializer is in Power Down mode. When the Deserializer is in Power Down. Programmed control register data are NOT retained and reset to default values.
LOCK	34	Output, LVCMOS	LOCK Status Output Pin. LOCK = H, PLL is Locked, outputs are active LOCK = L, PLL is unlocked, ROUT and PCLK output states are controlled by OSS_SEL control register. May be used as Link Status.
RES	37, 38, 39, 43, 44, 46	-	Reserved. Pin 46: This pin MUST be tied LOW. Pin 37, 43, 44: Leave pin open. Pins 38, 39: Route to test point or leave open if unused.
NC	30, 31, 32, 33		No Connect
FPD-LINK II INTERFACE			
RIN+	41	Input, CML	Noninverting differential input. The interconnect must be AC Coupled with a 100 nF capacitor.
RIN-	42	Inputt, CML	Inverting differential input. The interconnect must be AC Coupled with a 100 nF capacitor.

Pin Name	Pin No.	I/O, Type	Description
POWER AND GROUND			
VDDSSCG	3	Power, Digital	SSCG Power, 1.8V ±5% Power supply must be connected regardless if SSCG function is in operation.
VDDIO1/2/3	29, 20, 7	Power, Digital	LVCMOS I/O Buffer Power, The single-ended outputs and control input are powered from V_{DDIO}. V_{DDIO} can be connected to a 1.8V ±5% or 3.3V ±10%
VDDD	17	Power, Digital	Digital Core Power, 1.8V ±5%
VDDR	36	Power, Analog	Rx Analog Power, 1.8V ±5%
VDDCML	40	Power, Analog	1.8V ±5%
VDDPLL	45	Power, Analog	PLL Power, 1.8V ±5%
VSS	DAP	Ground, DAP	DAP must be grounded. DAP is the large metal contact at the bottom side, located at the center of the LLP package. Connected to the ground plane (GND) with at least 16 vias.

Absolute Maximum Ratings (*Note 1*)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage – V_{DDn} (1.8V)	–0.3V to +2.5V
Supply Voltage – V_{DDIO}	–0.3V to +4.0V
LVCMOS Input Voltage I/O Voltage	–0.3V to + (VDDIO + 0.3V)
CML Driver I/O Voltage (V_{DD})	–0.3V to +(V_{DD} + 0.3V)
CML Receiver I/O Voltage (V_{DD})	–0.3V to (V_{DD} + 0.3V)
Junction Temperature	+150°C
Storage Temperature	–65°C to +150°C
Maximum Package Power Dissipation Capacity Package	1/θ_{JA} °C/W above +25°

Package Derating:

DS90UR903Q 40L LLP

θ_{JA}	30.7 °C/W
(based on 16 thermal vias)	
θ_{JC}	6.8 °C/W
(based on 16 thermal vias)	

DS90UR904Q 48L LLP

θ_{JA}	26.9 °C/W
(based on 16 thermal vias)	
θ_{JC}	4.4 °C/W
(based on 16 thermal vias)	

ESD Rating (IEC 61000-4-2)	R_D = 330Ω, C_S = 150pF
Air Discharge (DOUT+, DOUT-, RIN+, RIN-)	≥±25 kV
Contact Discharge (DOUT+, DOUT-, RIN+, RIN-)	≥±10 kV
ESD Rating (ISO10605)	R_D = 330Ω, C_S = 150/330pF

ESD Rating (ISO10605)	R_D = 2KΩ, C_S = 150/330pF
Air Discharge (DOUT+, DOUT-, RIN+, RIN-)	≥±15 kV
Contact Discharge (DOUT+, DOUT-, RIN+, RIN-)	≥±10 kV
ESD Rating (HBM)	≥±8 kV
ESD Rating (CDM)	≥±1 kV
ESD Rating (MM)	≥±250 V

For soldering specifications:
  see product folder at www.national.com and
  www.national.com/ms/MS/MS-SOLDERING.pdf

Recommended Operating Conditions

	Min	Nom	Max	Units
Supply Voltage (V_{DDn})	1.71	1.8	1.89	V
LVCMOS Supply Voltage (V_{DDIO}) OR	1.71	1.8	1.89	V
LVCMOS Supply Voltage (V_{DDIO})	3.0	3.3	3.6	V
Supply Noise				
V_{DDn} (1.8V)			25	mVp-p
V_{DDIO} (1.8V)			25	mVp-p
V_{DDIO} (3.3V)			50	mVp-p
Operating Free Air Temperature (T_A)	-40	+25	+105	°C
PCLK Clock Frequency	10		43	MHz

Electrical Characteristics (*Note 2*, *Note 3*, *Note 4*)

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
LVCMOS DC SPECIFICATIONS 3.3V I/O (SER INPUTS, DES OUTPUTS, CONTROL INPUTS AND OUTPUTS)						
V_{IH}	High Level Input Voltage	V_{IN} = 3.0V to 3.6V	2.0		V_{IN}	V
V_{IL}	Low Level Input Voltage	V_{IN} = 3.0V to 3.6V	GND		0.8	V
I_{IN}	Input Current	V_{IN} = 0V or 3.6V V_{IN} = 3.0V to 3.6V	-20	±1	+20	µA
V_{OH}	High Level Output Voltage	V_{DDIO} = 3.0V to 3.6V I_{OH} = -4 mA	2.4		V_{DDIO}	V
V_{OL}	Low Level Output Voltage	V_{DDIO} = 3.0V to 3.6V I_{OL} = +4 mA	GND		0.4	V
I_{OS}	Output Short Circuit Current	V_{OUT} = 0V		-39		mA
I_{OZ}	TRI-STATE® Output Current	PDB = 0V, V_{OUT} = 0V or V_{DD}	-20	±1	+20	µA
LVCMOS DC SPECIFICATIONS 1.8V I/O (SER INPUTS, DES OUTPUTS, CONTROL INPUTS AND OUTPUTS)						
V_{IH}	High Level Input Voltage	V_{IN} = 1.71V to 1.89V	0.65 V_{IN}		V_{IN} +0.3	V
V_{IL}	Low Level Input Voltage	V_{IN} = 1.71V to 1.89V	GND		0.35 V_{IN}	
I_{IN}	Input Current	V_{IN} = 0V or 1.89V V_{IN} = 1.71V to 1.89V	-20	±1	+20	µA

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V_{OH}	High Level Output Voltage	V_{DDIO} = 1.71V to 1.89V I_{OH} = −4 mA		V_{DDIO} - 0.45		V_{DDIO}	V
V_{OL}	Low Level Output Voltage	V_{DDIO} = 1.71V to 1.89V I_{OL} = +4 mA		GND		0.45	V
I_{OS}	Output Short Circuit Current	V_{OUT} = 0V			-20		mA
I_{OZ}	TRI-STATE® Output Current	PDB = 0V, V_{OUT} = 0V or V_{DD}		-20	±1	+20	μA
CML DRIVER DC SPECIFICATIONS (DOUT+, DOUT-)							
|V_{OD}|	Output Differential Voltage	R_T = 100Ω (*Figure 7*)		268	340	412	mV
ΔV_{OD}	Output Differential Voltage Unbalance	R_L = 100Ω			1	50	mV
V_{OS}	Output Differential Offset Voltage	R_L = 100Ω (*Figure 7*)		$V_{DD (MIN)}$ - $V_{OD (MAX)}$	V_{DD} - V_{OD}	$V_{DD (MAX)}$ - $V_{OD (MIN)}$	V
ΔV_{OS}	Offset Voltage Unbalance	R_L = 100Ω			1	50	mV
I_{OS}	Output Short Circuit Current	DOUT+/- = 0V			-27		mA
R_T	Differential Internal Termination Resistance	Differential across DOUT+ and DOUT-		80	100	120	Ω
CML RECEIVER DC SPECIFICATIONS (RIN+, RIN-)							
V_{TH}	Differential Threshold High Voltage	(*Figure 8*)				+90	mV
V_{TL}	Differential Threshold Low Voltage			-90			mV
V_{IN}	Differential Input Voltage Range	RIN+ - RIN-		180			mV
I_{IN}	Input Current	V_{IN} = V_{DD} or 0V, V_{DD} = 1.89V		-20	±1	+20	μA
R_T	Differential Internal Termination Resistance	Differential across RIN+ and RIN-		80	100	120	Ω
SER/DES SUPPLY CURRENT *DIGITAL, PLL, AND ANALOG VDD							
I_{DDT}	Serializer (Tx) VDDn Supply Current (includes load current)	R_T = 100Ω WORST CASE pattern (*Figure 5*)	VDDn = 1.89V PCLK = 43 MHz Default Registers		62	90	mA
		R_T = 100Ω RANDOM PRBS-7 pattern			55		
I_{DDIOT}	Serializer (Tx) VDDIO Supply Current (includes load current)	R_T = 100Ω WORST CASE pattern (*Figure 5*)	VDDIO = 1.89V PCLK = 43 MHz Default Registers		2	5	mA
			VDDIO = 3.6V PCLK = 43 MHz Default Registers		7	15	
I_{DDTZ}	Serializer (Tx) Supply Current Power-down	PDB = 0V; All other LVCMOS Inputs = 0V	V_{DDn} = 1.89V		370	775	μA
I_{DDIOTZ}			V_{DDIO} = 1.89V		55	125	
			V_{DDIO} = 3.6V		65	135	

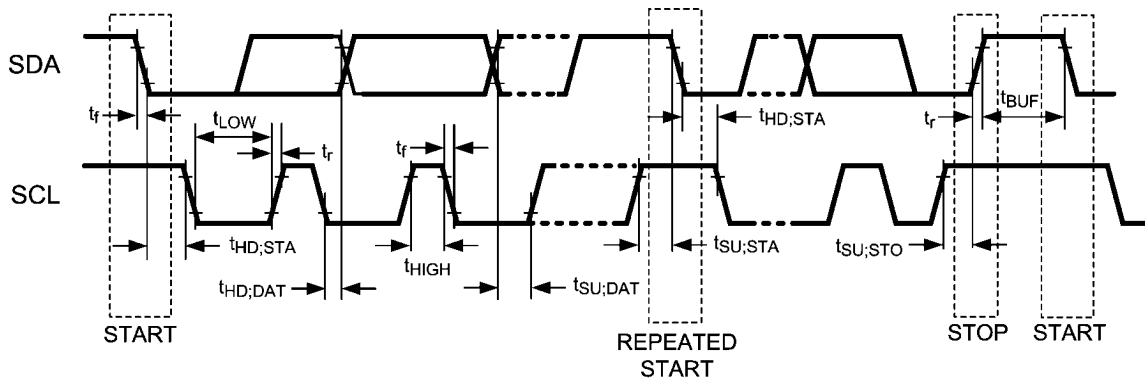| Symbol	Parameter	Conditions		Min	Typ	Max	Units
I_DDR	Deserializer (Rx) VDDn Supply Current (includes load current)	V_DDn = 1.89V C_L = 8 pF WORST CASE Pattern (*Figure 5*)	PCLK = 43 MHz SSCG[3:0] = ON Default Registers		60	96	mA
		V_DDn = 1.89V C_L = 8 pF RANDOM PRBS-7 Pattern	PCLK = 43 MHz Default Registers		53		
I_DDIOR	Deserializer (Rx) VDDIO Supply Current (includes load current)	V_DDIO = 1.89V C_L = 8 pF WORST CASE Pattern (*Figure 5*)	PCLK = 43 MHz Default Registers		21	32	
		V_DDIO = 3.6V C_L = 8 pF WORST CASE Pattern	PCLK = 43 MHz Default Registers		49	83	
I_DDRZ	Deserializer (Rx) Supply Current Power-down	PDB = 0V; All other LVCMOS Inputs = 0V	V_DDn = 1.89V		42	400	µA
I_DDIORZ			V_DDIO = 1.89V		8	40	
			V_DDIO = 3.6V		350	800	

Recommended Serializer Timing for PCLK (*Note 12*)

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_TCP	Transmit Clock Period	10 MHz – 43 MHz	23.3	T	100	ns
t_TCIH	Transmit Clock Input High Time		0.4T	0.5T	0.6T	ns
t_TCIL	Transmit Clock Input Low Time		0.4T	0.5T	0.6T	ns
t_CLKT	PCLK Input Transition Time (*Figure 9*)		0.5		3	ns
f_OSC	Internal oscillator clock source			25		MHz

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Serializer Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{LHT}	CML Low-to-High Transition Time	R_L = 100Ω (*Figure 6*)		150	330	ps
t_{HLT}	CML High-to-Low Transition Time	R_L = 100Ω (*Figure 6*)		150	330	ps
t_{DIS}	Data Input Setup to PCLK	Serializer Data Inputs (*Figure 10*)	2.0			ns
t_{DIH}	Data Input Hold from PCLK		2.0			ns
t_{PLD}	Serializer PLL Lock Time	R_L = 100Ω (*Note 5*, *Note 11*)		1	2	ms
t_{SD}	Serializer Delay	R_T = 100Ω PCLK = 10–43 MHz Register 0x03h b[0] (TRFB = 1) (*Figure 12*)	6.386T + 5	6.386T + 12	6.386T + 19.7	ns
t_{JIND}	Serializer Output Deterministic Jitter	Serializer output intrinsic deterministic jitter . Measured (cycle-cycle) with PRBS-7 test pattern PCLK = 43 MHz (*Note 4*, *Note 13*)		0.13		UI
t_{JINR}	Serializer Output Random Jitter	Serializer output intrinsic random jitter (cycle-cycle). Alternating-1,0 pattern. PCLK = 43 MHz (*Note 4*, *Note 13*)		0.04		UI
t_{JINT}	Peak-to-peak Serializer Output Jitter	Serializer output peak-to-peak jitter includes deterministic jitter, random jitter, and jitter transfer from serializer input. Measured (cycle-cycle) with PRBS-7 test pattern. PCLK = 43 MHz (*Note 4*, *Note 13*)		0.396		UI
λ_{STXBW}	Serializer Jitter Transfer Function -3 dB Bandwidth	PCLK = 43 MHz Default Registers (*Figure 18*) (*Note 4*)		1.90		MHz
δ_{STX}	Serializer Jitter Transfer Function (Peaking)	PCLK = 43 MHz Default Registers (*Figure 18*) (*Note 4*)		0.944		dB
δ_{STXf}	Serializer Jitter Transfer Function (Peaking Frequency)	PCLK = 43 MHz Default Registers (*Figure 18*) (*Note 4*)		500		kHz

Deserializer Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Pin/Freq.	Min	Typ	Max	Units
t_{RCP}	Receiver Output Clock Period	$t_{RCP} = t_{TCP}$	PCLK	23.3	T	100	ns
t_{PDC}	PCLK Duty Cycle	Default Registers SSCG[3:0] = OFF	PCLK	45	50	55	%
t_{CLH}	LVCMOS Low-to-High Transition Time	V_{DDIO}: 1.71V to 1.89V or 3.0 to 3.6V,	PCLK	1.3	2.0	2.8	ns
t_{CHL}	LVCMOS High-to-Low Transition Time	C_L = 8 pF (lumped load) Default Registers (*Figure 14*) (*Note 10*)		1.3	2.0	2.8	
t_{CLH}	LVCMOS Low-to-High Transition Time	V_{DDIO}: 1.71V to 1.89V or 3.0 to 3.6V,	Deserializer ROUTn Data Outputs	1.6	2.4	3.3	ns
t_{CHL}	LVCMOS High-to-Low Transition Time	C_L = 8 pF (lumped load) Default Registers (*Figure 14*) (*Note 10*)		1.6	2.4	3.3	
t_{ROS}	ROUT Setup Data to PCLK	V_{DDIO}: 1.71V to 1.89V or 3.0V to 3.6V,	Deserializer ROUTn Data Outputs	0.38T	0.5T		ns
t_{ROH}	ROUT Hold Data to PCLK	C_L = 8 pF (lumped load) Default Registers		0.38T	0.5T		
t_{DD}	Deserializer Delay	Default Registers Register 0x03h b[0] (RRFB = 1) (*Figure 15*)	10 MHz–43 MHz	4.571T + 8	4.571T + 12	4.571T + 16	ns
t_{DDLT}	Deserializer Data Lock Time	(*Figure 13*) (*Note 5*)	10 MHz–43 MHz			10	ms
t_{RJIT}	Receiver Input Jitter Tolerance	(*Figure 17*, *Figure 19*) (*Note 13*, *Note 14*)	43 MHz		0.53		UI
t_{RCJ}	Receiver Clock Jitter	PCLK SSCG[3:0] = OFF (*Note 6*, *Note 10*)	10 MHz		300	550	ps
			43 MHz		120	250	
t_{DPJ}	Deserializer Period Jitter	PCLK SSCG[3:0] = OFF (*Note 7*, *Note 10*)	10 MHz		425	600	ps
			43 MHz		320	480	
t_{DCCJ}	Deserializer Cycle-to-Cycle Clock Jitter	PCLK SSCG[3:0] = OFF (*Note 8*, *Note 10*)	10 MHz		320	500	ps
			43 MHz		300	500	
fdev	Spread Spectrum Clocking Deviation Frequency	LVCMOS Output Bus SSC[3:0] = ON (*Figure 20*)	20 MHz–43 MHz		±0.5% to ±2.0%		%
fmod	Spread Spectrum Clocking Modulation Frequency		20 MHz–43 MHz		9 kHz to 66 kHz		kHz

Serial Control Bus AC Timing Specifications (SCL, SDA) - I2C Compliant (*Figure 4*)

Over recommended supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
RECOMMENDED INPUT TIMING REQUIREMENTS (*Note 12*)						
f_{SCL}	SCL Clock Frequency		>0		100	kHz
t_{LOW}	SCL Low Period	f_{SCL} = 100 kHz	4.7			µs
t_{HIGH}	SCL High Period		4.0			µs
$t_{HD:STA}$	Hold time for a start or a repeated start condition		4.0			µs
$t_{SU:STA}$	Set Up time for a start or a repeated start condition		4.7			µs
$t_{HD:DAT}$	Data Hold Time		0		3.45	µs
$t_{SU:DAT}$	Data Set Up Time		250			ns
$t_{SU:STO}$	Set Up Time for STOP Condition		4.0			µs
t_r	SCL & SDA Rise Time				1000	ns
t_f	SCL & SDA Fall Time				300	ns
C_b	Capacitive load for bus				400	pF
SWITCHING CHARACTERISTICS (*Note 11*)						
$t_{HD:DAT}$	Data Hold Time		0		3.45	µs
$t_{SU:DAT}$	Data Set Up Time		250			ns
t_f	SCL & SDA Fall Time				300	ns

FIGURE 4. Serial Control Bus Timing

Serial Control Bus DC Characteristics (SCL, SDA) - I2C Compliant

Over recommended supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{IH}	Input High Level	SDA and SCL	0.7 x V_{DDIO}		V_{DDIO}	V
V_{IL}	Input Low Level Voltage	SDA and SCL	GND		0.3 x V_{DDIO}	V
V_{HY}	Input Hysteresis	SDA and SCL		>50		mV
I_{OZ}	TRI-STATE Output Current	PDB = 0V V_{OUT} = 0V or V_{DD}	-20	±1	+20	µA
I_{IN}	Input Current	SDA or SCL, Vin = V_{DDIO} or GND	-20	±1	+20	µA

Symbol	Parameter	Conditions	Min	Typ	Max	Units
C_{IN}	Input Pin Capacitance			<5		pF
V_{OL}	Low Level Output Voltage	SCL and SDA V_{DDIO} = 3.0V I_{OL} = 1.5mA			0.36	V
		SCL and SDA V_{DDIO} = 1.71V I_{OL} = 1mA			0.36	V

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional; the device should not be operated beyond such conditions.

Note 2: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Note 3: Current into device pins is defined as positive. Current out of a device pin is defined as negative. Voltages are referenced to ground except VOD, ΔVOD, VTH and VTL which are differential voltages.

Note 4: Typical values represent most likely parametric norms at 1.8V or 3.3V, T_A = +25°C, and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

Note 5: t_{PLD} and t_{DDLT} is the time required by the serializer and deserializer to obtain lock when exiting power-down state with an active PCLK

Note 6: t_{DCJ} is the maximum amount of jitter measured over 30,000 samples based on Time Interval Error (TIE).

Note 7: t_{DPJ} is the maximum amount the period is allowed to deviate measured over 30,000 samples.

Note 8: t_{DCCJ} is the maximum amount of jitter between adjacent clock cycles measured over 30,000 samples.

Note 9: Supply noise testing was done with minimum capacitors (as shown on Figures 27, 28) on the PCB. A sinusoidal signal is AC coupled to the VDDn (1.8V) supply with amplitude = 25 mVp-p measured at the device VDDn pins. Bit error rate testing of input to the Ser and output of the Des with 10 meter cable shows no error when the noise frequency on the Ser is less than 1 MHz. The Des on the other hand shows no error when the noise frequency is less than 750 kHz.

Note 10: Specification is guaranteed by characterization and is not tested in production.

Note 11: Specification is guaranteed by design.

Note 12: Recommended Input Timing Requirements are input specifications and not tested in production.

Note 13: UI – Unit Interval is equivalent to one ideal serialized data bit width. The UI scales with PCLK frequency.

Note 14: t_{RJIT} max (0.61UI) is limited by instrumentation and actual t_{RJIT} of in-band jitter at low frequency (<2 MHz) is greater 1 UI.

AC Timing Diagrams and Test Circuits
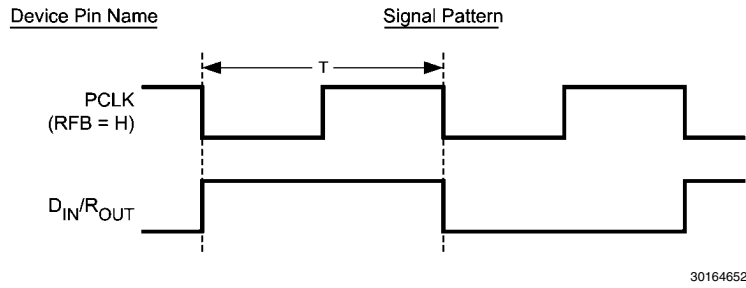
30164652

FIGURE 5. "Worst Case" Test Pattern

$$Vdiff = (D_{OUT}+) - (D_{OUT}-)$$
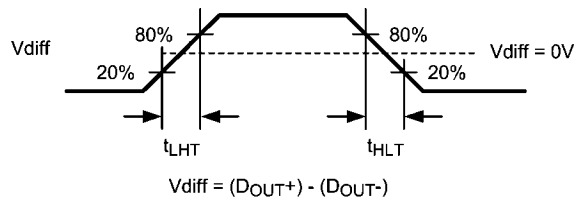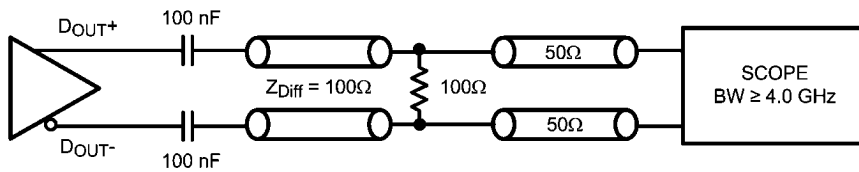
30164646
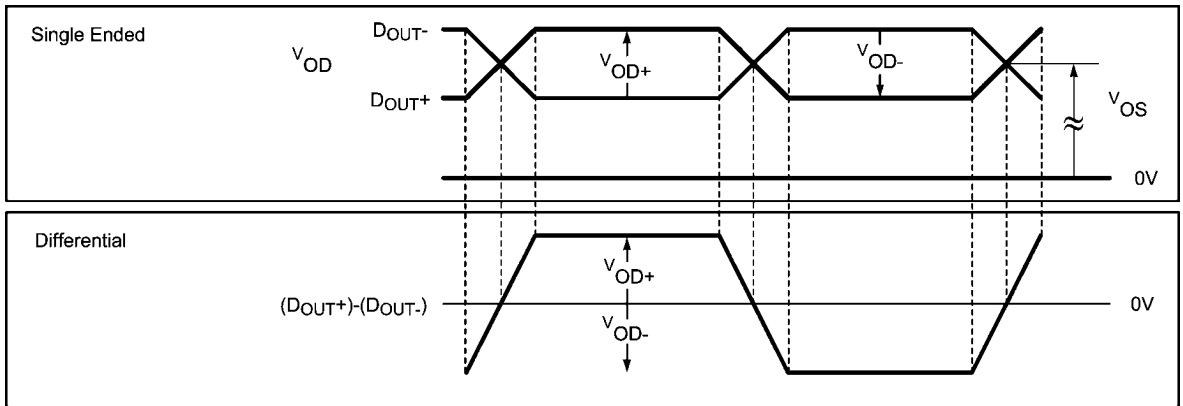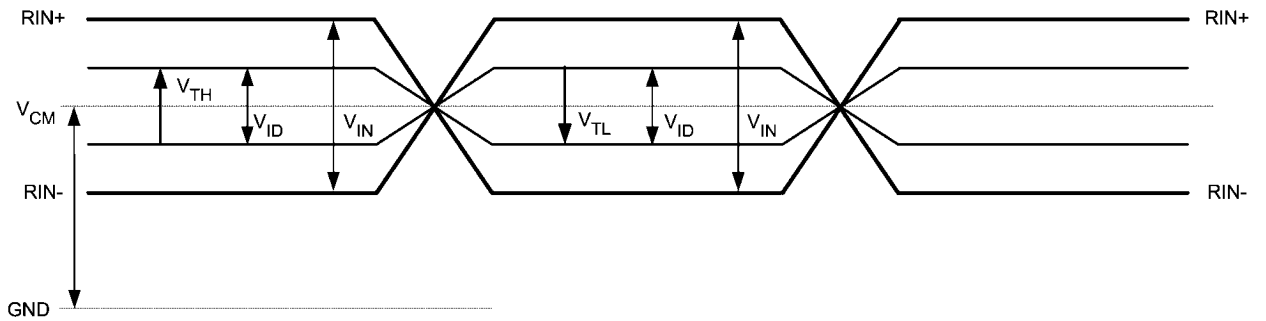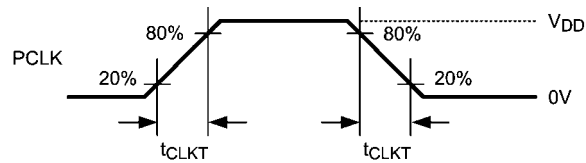

30164647

FIGURE 6. Serializer CML Output Load and Transition Times
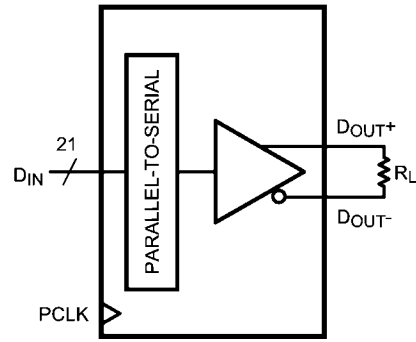
FIGURE 7. Serializer VOD DC Diagram

FIGURE 8. Differential VTH/VTL Definition Diagram

FIGURE 9. Serializer Input Clock Transition Times

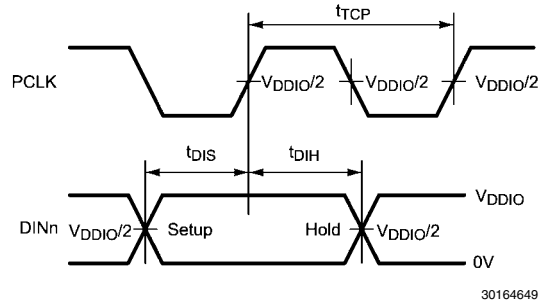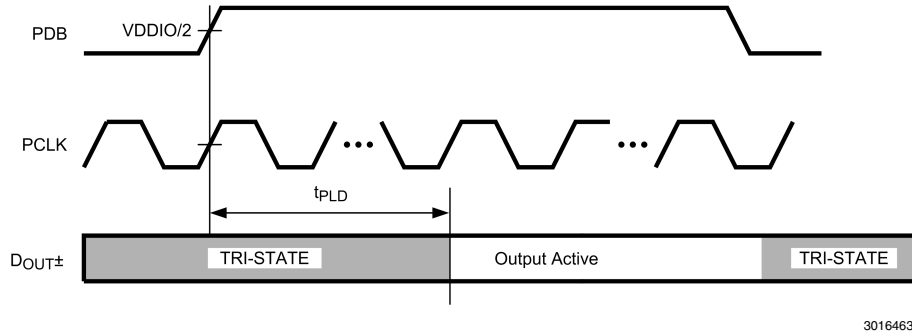**FIGURE 10. Serializer Setup/Hold Times**
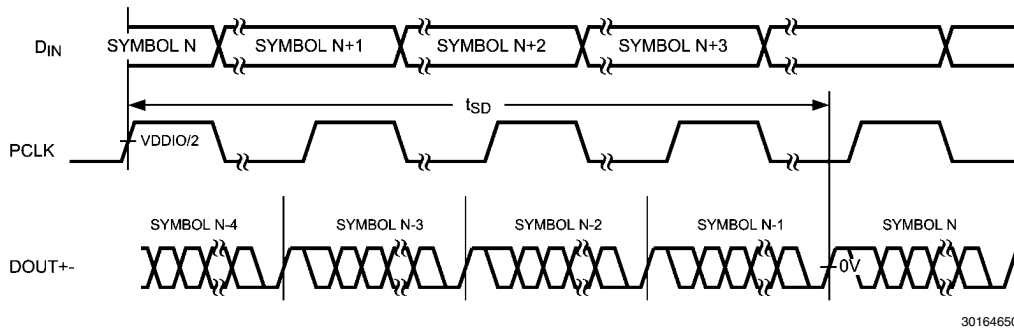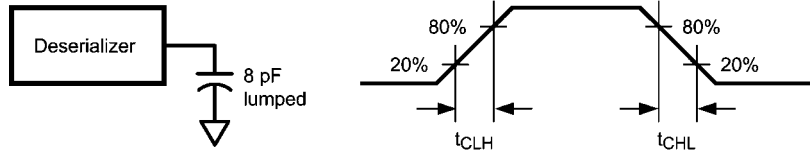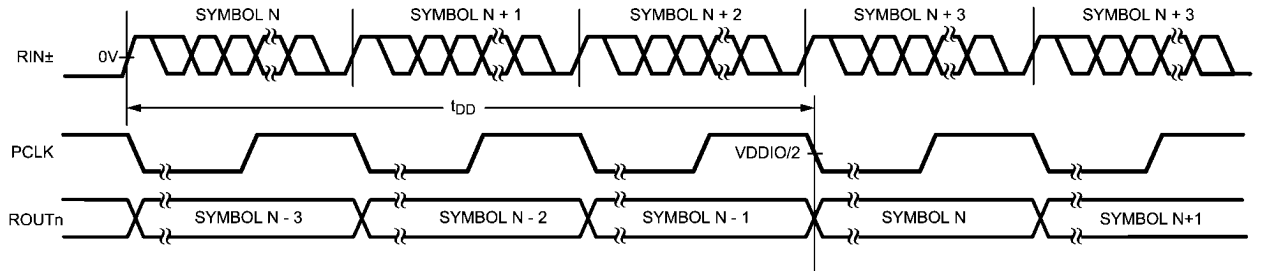

FIGURE 11. Serializer Data Lock Time

FIGURE 12. Serializer Delay
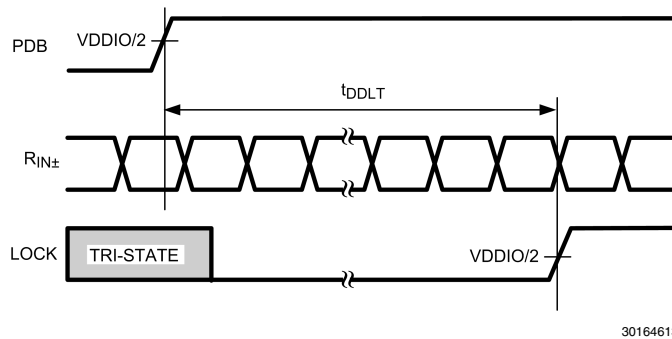
FIGURE 13. Deserializer Data Lock Time

FIGURE 14. Deserializer LVCMOS Output Load and Transition Times

FIGURE 15. Deserializer Delay
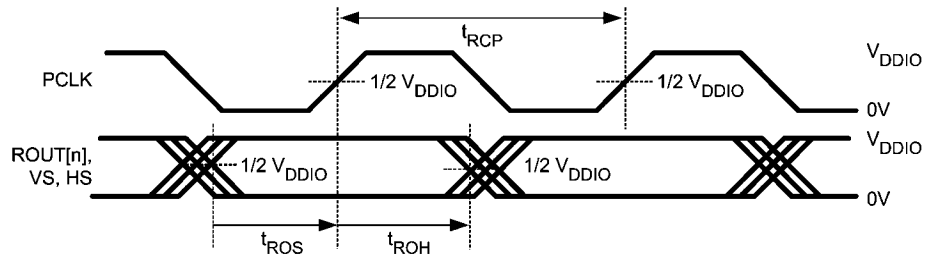
FIGURE 16. Deserializer Output Setup/Hold Times
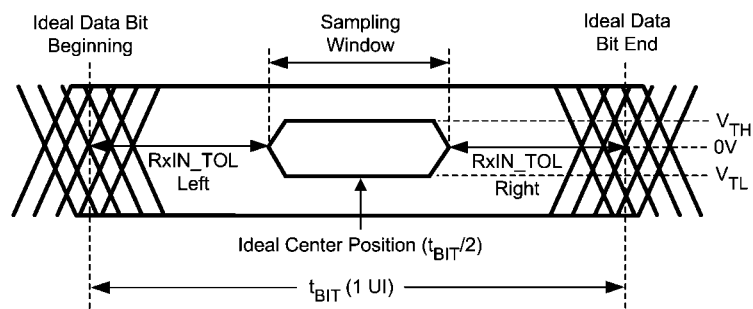
t_{RJIT} = RxIN_TOL (Left + Right)

Sampling Window = 1 UI − t_{RJIT}

FIGURE 17. Receiver Input Jitter Tolerance
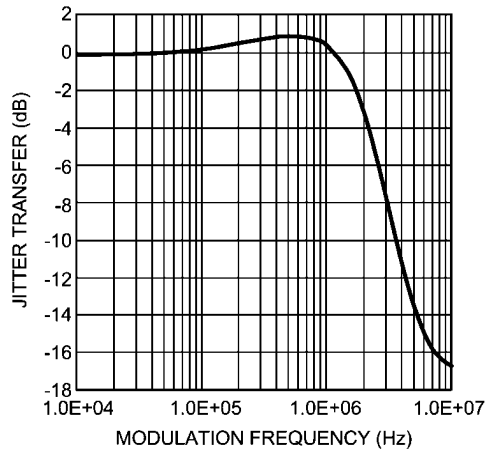
30164662

FIGURE 18. Typical Serializer Jitter Transfer Function Curve at 43 MHz
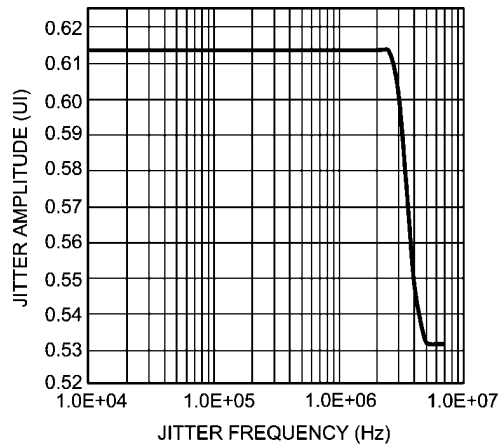
30164659

FIGURE 19. Typical Deserializer Input Jitter Tolerance Curve at 43 MHz
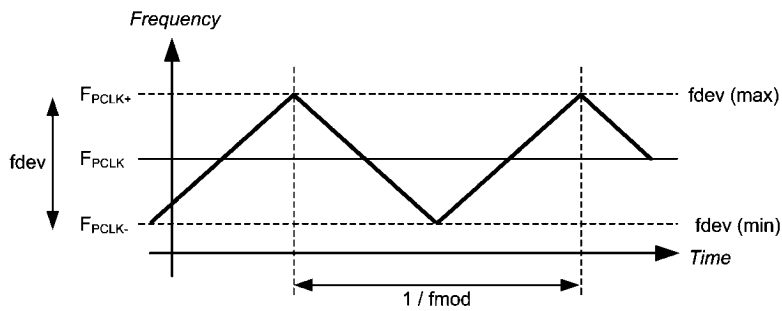
30164635

FIGURE 20. Spread Spectrum Clock Output Profile

TABLE 1. DS90UR903Q Control Registers

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
0	I²C Device ID	7:1	DEVICE ID	RW	0xB0'h	7-bit address of Serializer; 0x58'h (1011_000X'b) default
		0	SER ID SEL			0: Device ID is from ID[x] 1: Register I²C Device ID overrides ID[x]
1	Reset	7:3	RESERVED		0x00'h	Reserved
		2	RESERVED	RW	0	Reserved
		1	DIGITAL RESET0	RW	0 self clear	1: Resets the device to default register values. Does not affect device I²C Bus or Device ID
		0	DIGITAL RESET1	RW	0 self clear	1: Digital Reset, retains all register values
2	Reserved	7:0	RESERVED		0x20'h	Reserved
3	Reserved	7:6	RESERVED		11'b	Reserved
	VDDIO Control	5	VDDIO CONTOL	RW	1	Auto V_{DDIO} detect Allows manual setting of VDDIO by register. 0: Disable 1: Enable (auto detect mode)
	VDDIO Mode	4	VDDIO MODE	RW	1	VDDIO voltage set Only used when VDDIOCONTROL = 0 0: 1.8V 1: 3.3V
	RESERVED	3	RESERVED	RW	1	Reserved
	RESERVED	2	RESERVED		0	Reserved
	PCLK_AUTO	1	PCLK_AUTO	RW	1	Switch over to internal 25 MHz Oscillator clock in the absence of PCLK 0: Disable 1: Enable
	TRFB	0	TRFB	RW	1	Pixel Clock Edge Select: 0: Parallel Interface Data is strobed on the Falling Clock Edge. 1: Parallel Interface Data is strobed on the Rising Clock Edge.
4	Reserved	7:0	RESERVED		0x80'h	Reserved
5	Reserved	7:0	RESERVED	RW	0x40'h	Reserved
6	Reserved	7:0	RESERVED	RW	0xC0'h	Reserved
7	Reserved	7:0	RESERVED	RW	0x00'h	Reserved
8	Reserved	7:0	RESERVED		0x00'h	Reserved
9	Reserved	7:0	RESERVED		0x01'h	Reserved
A	Reserved	7:0	RESERVED		0x00'h	Reserved
B	Reserved	7:0	RESERVED		0x00'h	Reserved
C	Reserved	7:3	RESERVED		0x00'h	Reserved
	PCLK Detect	2	PCLK DETECT	R	0	1: Valid PCLK detected 0: Valid PCLK not detected
	Reserved	3	RESERVED		0	Reserved
	Reserved	0	RESERVED	R	0	Reserved
D	Reserved	7:0	RESERVED		0x11'h	Reserved
E	Reserved	7:0	RESERVED		0x01'h	Reserved
F	Reserved	7:0	RESERVED		0x03'h	Reserved
10	Reserved	7:0	RESERVED		0x03'h	Reserved
11	Reserved	7:0	RESERVED		0x03'h	Reserved

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
12	Reserved	7:0	RESERVED		0x03'h	Reserved
13	General Purpose Control Reg	7:0	GPCR[7] GPCR[6] GPCR[5] GPCR[4] GPCR[3] GPCR[2] GPCR[1] GPCR[0]	RW	0x00'h	0: LOW 1: HIGH

TABLE 2. DS90UR904Q Control Registers

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
0	I²C Device ID	7:1	DEVICE ID	RW	0xC0'h	7-bit address of Deserializer; 0x60h (1100_000X) default
		0	DES ID SEL			0: Device ID is from ID[x] 1: Register I²C Device ID overrides ID[x]
1	Reset	7:3	RESERVED		0x00'h	Reserved
		2	RESERVED	RW	0	Reserved
		1	DIGITALRESET0	RW	0 self clear	1: Resets the device to default register values. Does not affect device I²C Bus or Device ID
		0	DIGITALRESET1	RW	0 self clear	1: Digital Reset, retains all register values
2	RESERVED	7:6	RESERVED		00'b	Reserved
	Auto Clock	5	AUTO_CLOCK	RW	0	1: Output PCLK or Internal 25 MHz Oscillator clock 0: Only PCLK when valid PCLK present
	OSS Select	4	OSS_SEL	RW	0	Output Sleep State Select 0: Outputs = TRI-STATE, when LOCK = L 1: Outputs = LOW , when LOCK = L
	SSCG	3:0	SSCG		0000'b	SSCG Select 0000: Normal Operation, SSCG OFF (default) 0001: fmod (kHz) PCLK/2168, fdev ±0.50% 0010: fmod (kHz) PCLK/2168, fdev ±1.00% 0011: fmod (kHz) PCLK/2168, fdev ±1.50% 0100: fmod (kHz) PCLK/2168, fdev ±2.00% 0101: fmod (kHz) PCLK/1300, fdev ±0.50% 0110: fmod (kHz) PCLK/1300, fdev ±1.00% 0111: fmod (kHz) PCLK/1300, fdev ±1.50% 1000: fmod (kHz) PCLK/1300, fdev ±2.00% 1001: fmod (kHz) PCLK/868, fdev ±0.50% 1010: fmod (kHz) PCLK/868, fdev ±1.00% 1011: fmod (kHz) PCLK/868, fdev ±1.50% 1100: fmod (kHz) PCLK/868, fdev ±2.00% 1101: fmod (kHz) PCLK/650, fdev ±0.50% 1110: fmod (kHz) PCLK/650, fdev ±1.00% 1111: fmod (kHz) PCLK/650, fdev ±1.50%
3	RESERVED	7:6	RESERVED		11'b	Reserved
	VDDIO Control	5	VDDIO CONTROL	RW	1	Auto voltage control 0: Disable 1: Enable (auto detect mode)
	VDDIO Mode	4	VDDIO MODE	RW	0	VDDIO voltage set 0: 1.8V 1: 3.3V
	RESERVED	3	RESERVED	RW	1	Reserved
	RESERVED	2	RESERVED	RW	0	Reserved
	RESERVED	1	RESERVED		0	Reserved
	RRFB	0	RRFB	RW	1	Pixel Clock Edge Select 0: Parallel Interface Data is strobed on the Falling Clock Edge 1: Parallel Interface Data is strobed on the Rising Clock Edge.

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
4	EQ Control	7:0	EQ	RW	0x00'h	EQ Gain 00'h = ~0.0 dB 01'h = ~4.5 dB 03'h = ~6.5 dB 07'h = ~7.5 dB 0F'h = ~8.0 dB 1F'h = ~11.0 dB 3F'h = ~12.5 dB FF'h = ~14.0 dB
5	RESERVED	7:0	RESERVED		0x00'h	Reserved
6	RESERVED	7	RESERVED		0	Reserved
	RESERVED	6:4	RESERVED	RW	000'b	Reserved
	RESERVED	3:0	RESERVED	RW	1111'b	Reserved
7	RESERVED	7:0	RESERVED	RW	0xB0'h	Reserved
8:17	RESERVED	7:0	RESERVED	RW	0x00'h	Reserved
18	RESERVED	7:0	RESERVED		0x00'h	Reserved
19	RESERVED	7:0	RESERVED		0x01'h	Reserved
1A	RESERVED	7:0	RESERVED		0x00'h	Reserved
1B	RESERVED	7:0	RESERVED		0x00'h	Reserved
1C	RESERVED	7:3	RESERVED		0x00'h	Reserved
	RESERVED	2	RESERVED		0	Reserved
	Signal Detect Status	1		R	0	0: Active signal not detected 1: Active signal detected
	LOCK Pin Status	0		R	0	0: CDR/PLL Unlocked 1: CDR/PLL Locked
1D	Reserved	7:0	RESERVED		0x17'h	Reserved
1E	Reserved	7:0	RESERVED		0x07'h	Reserved
1F	Reserved	7:0	RESERVED		0x01'h	Reserved
20	Reserved	7:0	RESERVED		0x01'h	Reserved
21	Reserved	7:0	RESERVED		0x01'h	Reserved
22	Reserved	7:0	RESERVED		0x01'h	Reserved
23	General Purpose Control Reg	7:0	GPCR[7] GPCR[6] GPCR[5] GPCR[4] GPCR[3] GPCR[2] GPCR[1] GPCR[0]	RW	0x00'h	0: LOW 1: HIGH
24	RESERVED	0	RESERVED	RW	0	Reserved
25	RESERVED	7:0	RESERVED	R	0x00'h	Reserved
26	RESERVED	7:6	RESERVED	RW	00'b	Reserved
		5:0	RESERVED	RW	0	Reserved

Functional Description

The DS90UR903Q/904Q FPD-Link II chipset is intended for video display applications. The Serializer/ Deserializer chipset operates from a 10 MHz to 43 MHz pixel clock frequency. The DS90UR903Q transforms a 21-bit wide parallel LVCMOS data bus into a single high-speed differential pair. The high-speed serial bit stream contains an embedded clock and DC-balance information which enhances signal quality to support AC coupling. The DS90UR904Q receives the single serial data stream and converts it back into a 21-bit wide parallel data bus.

a 21 bit parallel video bus for 18-bit color depth (RGB666) display format. In a RGB666 configuration, 18 color bits (R [5:0], G[5:0], B[5:0]), Pixel Clock (PCLK) and three control bits (VS, HS and DE) are supported across the serial link.

The DS90UR903Q Serializer accepts a 21-bit parallel data bus. The parallel data is converted into a single differential link. The DS90UR904Q Deserializer extracts the clock/control information from the incoming data stream and reconstructs the 21-bit parallel data.

DISPLAY APPLICATION

The DS90UR903Q/904Q chipset is intended for interface between a host (graphics processor) and a Display. It supports
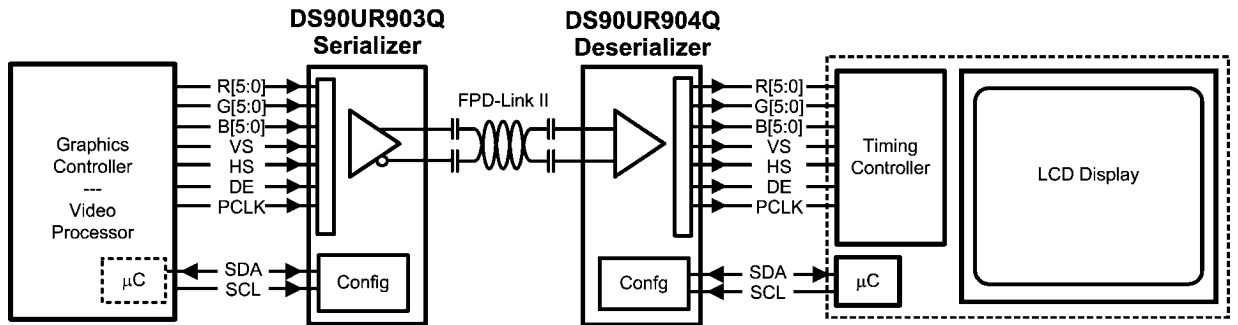
FIGURE 21. Typical Display System Diagram

CAMERA APPLICATION

Camera applications are also supported by the DS90UR903Q/904Q chipset. The host controller/processsor

is connected to the deserializer, while the CMOS image sensor provides data to the serializer.
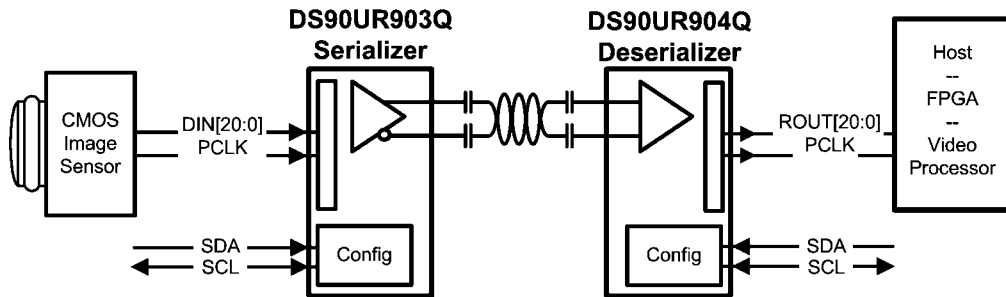
FIGURE 22. Typical Camera System Diagram

SERIAL FRAME FORMAT

The DS90UR903Q/904Q chipset will transmit and receive a pixel of data in the following format:
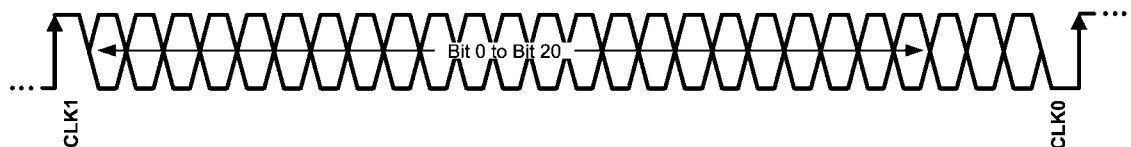
FIGURE 23. Serial Bitstream for 28-bit Symbol

The High Speed Serial Channel is a 28-bit symbol composed of 21 bits of data containing video data & control information transmitted from Serializer to Deserializer. CLK1 and CLK0 represent the embedded clock in the serial stream. CLK1 is always HIGH and CLK0 is always LOW. This data payload is optimized for signal transmission over an AC coupled link. Data is randomized, balanced and scrambled.

DESCRIPTION OF SERIAL CONTROL BUS

ID[X] ADDRESS DECODER

The ID[x] pin is used to decode and set the physical slave address of the Serializer/Deserializer (I2C only) to allow up to six devices on the bus using only a single pin. The pin sets one of six possible addresses for each Serializer/Deserializer device. The pin must be pulled to VDD (1.8V, NOT VDDIO)) with a 10 kΩ resistor and a pull down resistor (RID) of the recommended value to set the physical device address. The recommended maximum resistor tolerance is 0.1% worst case (0.2% total tolerance).
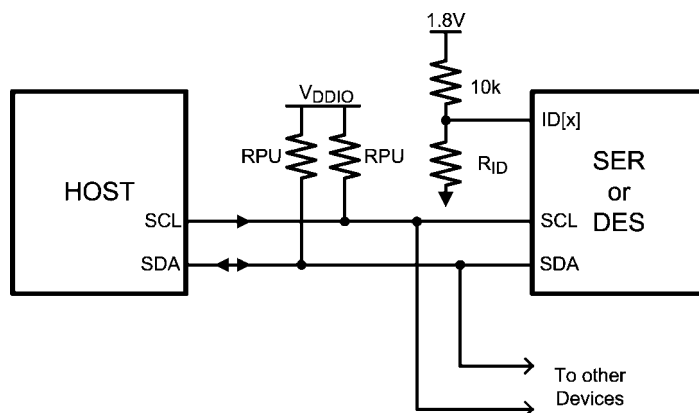
30164643

FIGURE 24. Serial Control Bus Connection

TABLE 3. ID[x] Resistor Value – DS90UR903Q

ID[x] Resistor Value - DS90UR903Q Ser		
Resistor RID Ω (±0.1%)	Address 7'b (*Note 11*)	Address 8'b 0 appended (WRITE)
0 GND	7b' 101 1000 (h'58)	8b' 1011 0000 (h'B0)
2.0k	7b' 101 1001 (h'59)	8b' 1011 0010 (h'B2)
4.7k	7b' 101 1010 (h'5A)	8b' 1011 0100 (h'B4)
8.2k	7b' 101 1011 (h'5B)	8b' 1011 0110 (h'B6)
12.1k	7b' 101 1100 (h'5C)	8b' 1011 1000 (h'B8)
39.0k	7b' 101 1110 (h'5E)	8b' 1011 1100 (h'BC)

TABLE 4. ID[x] Resistor Value – DS90UR904Q

ID[x] Resistor Value - DS90UR904Q Des		
Resistor RID Ω (±0.1%)	Address 7'b (*Note 11*)	Address 8'b 0 appended (WRITE)
0 GND	7b' 110 0000 (h'60)	8b' 1100 0000 (h'C0)
2.0k	7b' 110 0001 (h'61)	8b' 1100 0010 (h'C2)
4.7k	7b' 110 0010 (h'62)	8b' 1100 0100 (h'C4)
8.2k	7b' 110 0011 (h'63)	8b' 1101 0110 (h'C6)
12.1k	7b' 110 0100 (h'64)	8b' 1101 1000 (h'C8)
39.0k	7b' 110 0110 (h'66)	8b' 1100 1100 (h'CC)

PROGRAMMABLE CONTROLLER

An integrated I2C slave controller is embedded in each of the DS90UR903Q Serializer and DS90UR904Q Deserializer. It must be used to access and program the extra features embedded within the configuration registers. Refer to *Table 1* and *Table 2* for details of control registers.

LVCMOS VDDIO OPTION

1.8V or 3.3V SER Inputs and DES Outputs are user selectable to provide compatibility with 1.8V and 3.3V system interfaces.

POWERDOWN

The SER has a PDB input pin to ENABLE or Powerdown the device. The modes can be controlled by the host and is used to disable the Link to save power when the remote device is not operational. An auto mode is also available. In this mode, the PDB pin is tied High and the SER switches over to an internal oscillator when the PCLK stops or not present. When a PCLK starts again, the SER will then lock to the valid input PCLK and transmits the data to the DES. In powerdown mode, the high-speed driver outputs are static (High).

The DES has a PDB input pin to ENABLE or Powerdown the device. This pin can be controlled by the system and is used to disable the DES to save power. An auto mode is also available. In this mode, the PDB pin is tied High and the DES will enter powerdown when the serial stream stops. When the serial stream starts up again, the DES will lock to the input stream and assert the LOCK pin and output valid data. In powerdown mode, the Data and PCLK outputs are set by the OSS_SEL control register.

POWER UP REQUIREMENTS AND PDB PIN

It is required to delay and release the PDB input signal after VDD (VDDn and VDDIO) power supplies have settled to the recommended operating voltages. A external RC network can be connected to the PDB pin to ensure PDB arrives after all the VDD have stabilized.

SIGNAL QUALITY ENHANCERS

Des - Receiver Input Equalization (EQ)

The receiver inputs provided input equalization filter in order to compensate for loss from the media. The level of equalization is controlled via register setting.

EMI REDUCTION

Des - Receiver Staggered Output

The Receiver staggered outputs allows for outputs to switch in a random distribution of transitions within a defined window. Outputs transitions are distributed randomly. This minimizes the number of outputs switching simultaneously and helps to reduce supply noise. In addition it spreads the noise spectrum out reducing overall EMI.

Des Spread Spectrum Clocking

The DS90UR904Q parallel data and clock outputs have programmable SSCG ranges from 9 kHz–66 kHz and ±0.5%–±2% from 20 MHz to 43 MHz. The modulation rate and modulation frequency variation of output spread is controlled through the SSC control registers.

PIXEL CLOCK EDGE SELECT (TRFB/RRFB)

The TRFB/RRFB selects which edge of the Pixel Clock is used. For the SER, this register determines the edge that the data is latched on. If TRFB register is 1, data is latched on the Rising edge of the PCLK. If TRFB register is 0, data is latched on the Falling edge of the PCLK. For the DES, this register determines the edge that the data is strobed on. If RRFB register is 1, data is strobed on the Rising edge of the PCLK. If RRFB register is 0, data is strobed on the Falling edge of the PCLK.
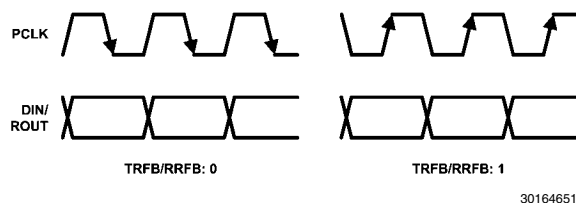
FIGURE 25. Programmable PCLK Strobe Select

Applications Information

AC COUPLING

The SER/DES supports only AC-coupled interconnects through an integrated DC balanced decoding scheme. Exter-

nal AC coupling capacitors must be placed in series in the FPD-Link II signal path as illustrated in *Figure 26*.
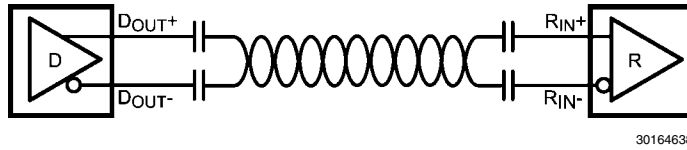

FIGURE 26. AC-Coupled Connection

For high-speed FPD-Link II transmissions, the smallest available package should be used for the AC coupling capacitor. This will help minimize degradation of signal quality due to package parasitics. The I/O's require a 100 nF AC coupling capacitors to the line.

TYPICAL APPLICATION CONNECTION

Figure 27 shows a typical connection of the DS90UR903Q Serializer.
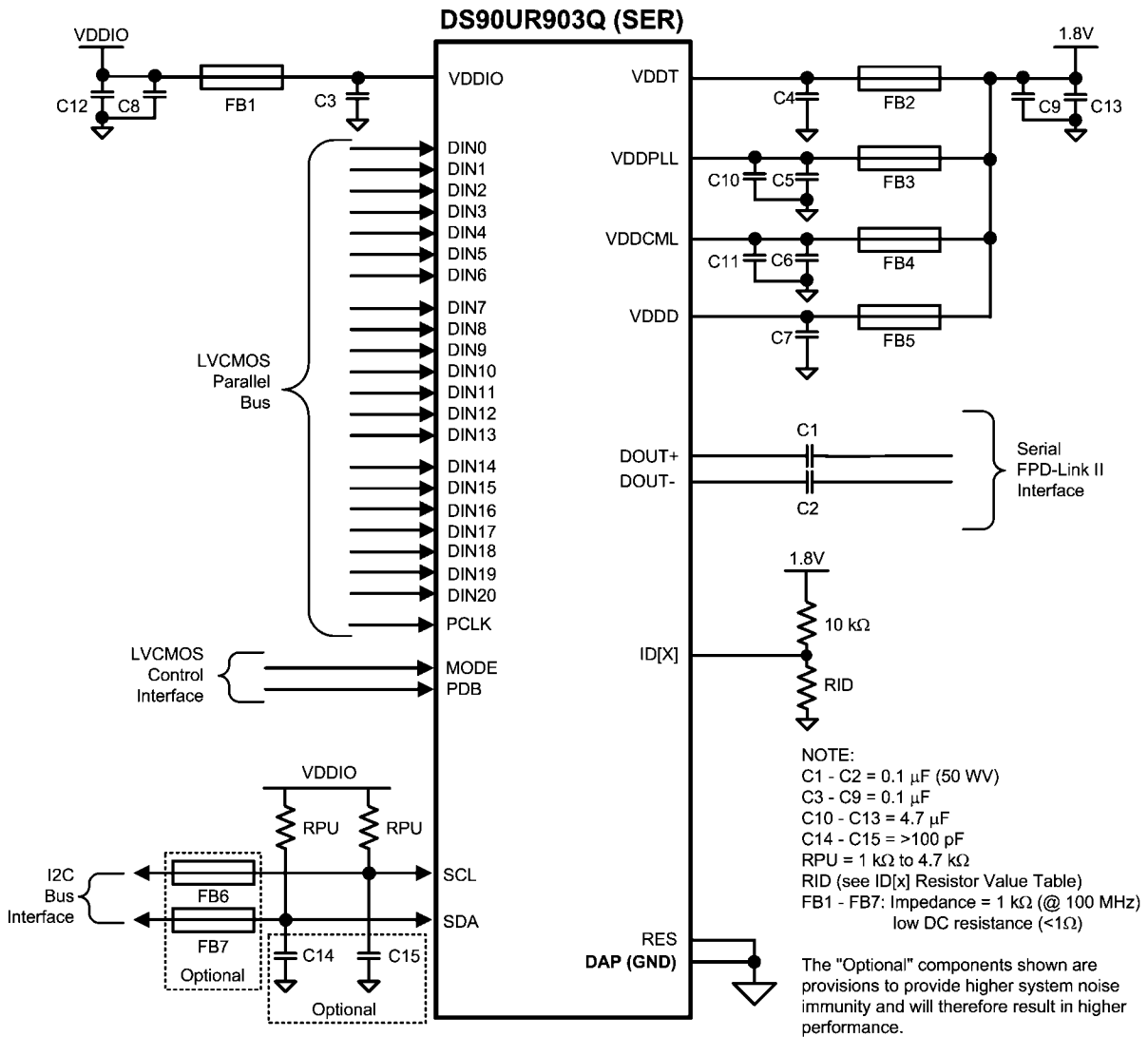
FIGURE 27. DS90UR903Q Typical Connection Diagram — Pin Control

NOTE:
C1 - C2 = 0.1 µF (50 WV)
C3 - C9 = 0.1 µF
C10 - C13 = 4.7 µF
C14 - C15 = >100 pF
RPU = 1 kΩ to 4.7 kΩ
RID (see ID[x] Resistor Value Table)
FB1 - FB7: Impedance = 1 kΩ (@ 100 MHz)
    low DC resistance (<1Ω)

The "Optional" components shown are provisions to provide higher system noise immunity and will therefore result in higher performance.

Figure 28 shows a typical connection of the DS90UR904Q Deserializer.

FIGURE 28. DS90UR904Q Typical Connection Diagram — Pin Control

TRANSMISSION MEDIA

The Ser/Des chipset is intended to be used over a wide variety of balanced cables depending on distance and signal quality requirements. The Ser/Des employ internal termination providing a clean signaling environment. The interconnect for FPD-Link II interface should present a differential impedance of 100 Ohms. Use of cables and connectors that have matched differential impedance will minimize impedance discontinuities. Shielded or un-shielded cables may be used depending upon the noise environment and application requirements. The chipset's optimum cable drive performance is achieved at 43 MHz at 10 meters length. The maximum signaling rate increases as the cable length decreases. Therefore, the chipset supports 50 MHz at shorter distances.

Other cable parameters that may limit the cable's performance boundaries are: cable attenuation, near-end crosstalk and pair-to-pair skew.

For obtaining optimal performance, we recommend:

• Use Shielded Twisted Pair (STP) cable
• 100Ω differential impedance and 24 AWG (or lower AWG) cable
• Low skew, impedance matched
• Ground and/or terminate unused conductors

Figure 29 shows the Typical Performance Characteristics demonstrating various lengths and data rates using Rosenberger HSD and Leoni DACAR 538 Cable.
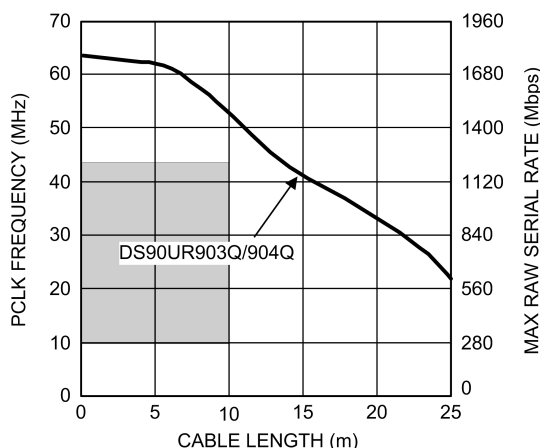
*Note: Equalization is enabled for cable lengths greater than 7 meters

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FIGURE 29. Rosenberger HSD & Leoni DACAR 538 Cable Performance

PCB LAYOUT AND POWER SYSTEM CONSIDERATIONS

Circuit board layout and stack-up for the Ser/Des devices should be designed to provide low-noise power feed to the device. Good layout practice will also separate high frequency or high-level inputs and outputs to minimize unwanted stray noise pickup, feedback and interference. Power system performance may be greatly improved by using thin dielectrics (2 to 4 mils) for power / ground sandwiches. This arrangement provides plane capacitance for the PCB power system with low-inductance parasitics, which has proven especially effective at high frequencies, and makes the value and placement of external bypass capacitors less critical. External bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range of 0.01 uF to 0.1 uF. Tantalum capacitors may be in the 2.2 uF to 10 uF range. Voltage rating of the tantalum capacitors should be at least 5X the power supply voltage being used.

Surface mount capacitors are recommended due to their smaller parasitics. When using multiple capacitors per supply pin, locate the smaller value closer to the pin. A large bulk capacitor is recommend at the point of power entry. This is typically in the 50uF to 100uF range and will smooth low frequency switching noise. It is recommended to connect power and ground pins directly to the power and ground planes with bypass capacitors connected to the plane with via on both ends of the capacitor. Connecting power or ground pins to an external bypass capacitor will increase the inductance of the path.

A small body size X7R chip capacitor, such as 0603, is recommended for external bypass. Its small body size reduces the parasitic inductance of the capacitor. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20-30 MHz. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Some devices provide separate power for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description tables typically provide guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter many be used to provide clean power to sensitive circuits such as PLLs.

Use at least a four layer board with a power and ground plane. Locate LVCMOS signals away from the differential lines to prevent coupling from the LVCMOS lines to the differential lines. Closely-coupled differential lines of 100 Ohms are typically recommended for differential interconnect. The closely coupled lines help to ensure that coupled noise will appear as common-mode and thus is rejected by the receivers. The tightly coupled lines will also radiate less.

Information on the LLP style package is provided in National Application Note: AN-1187.
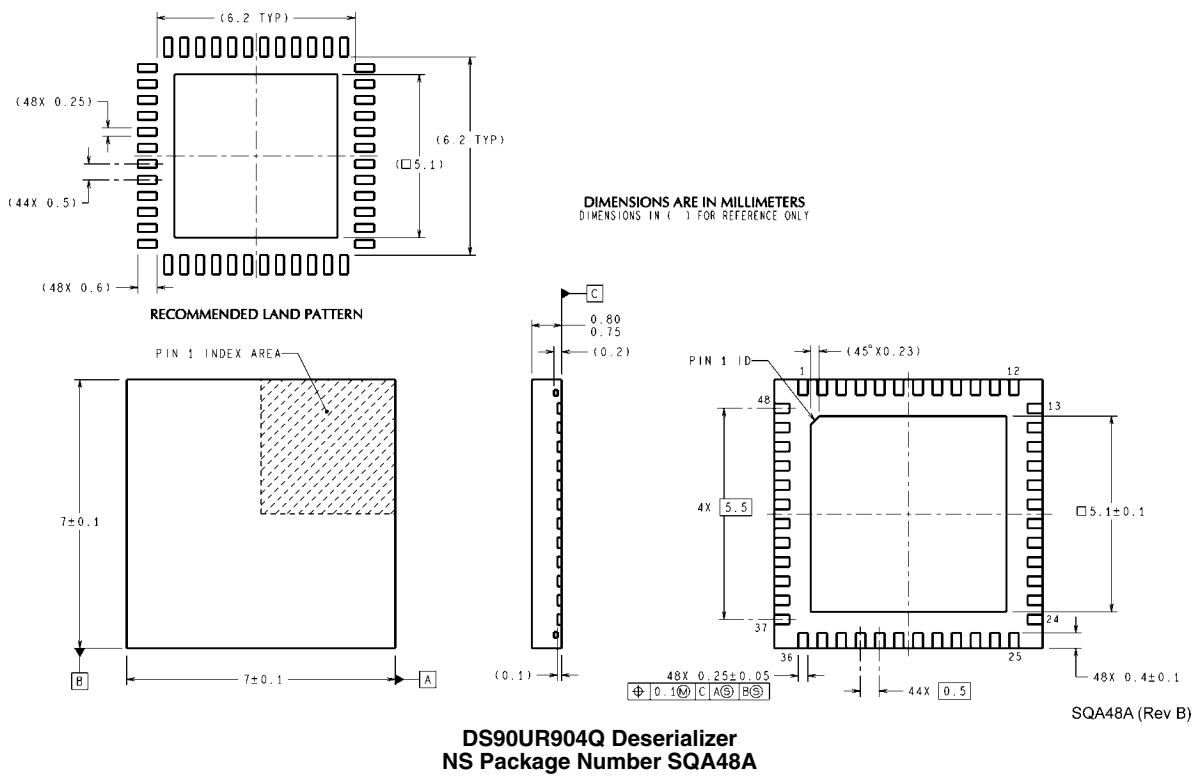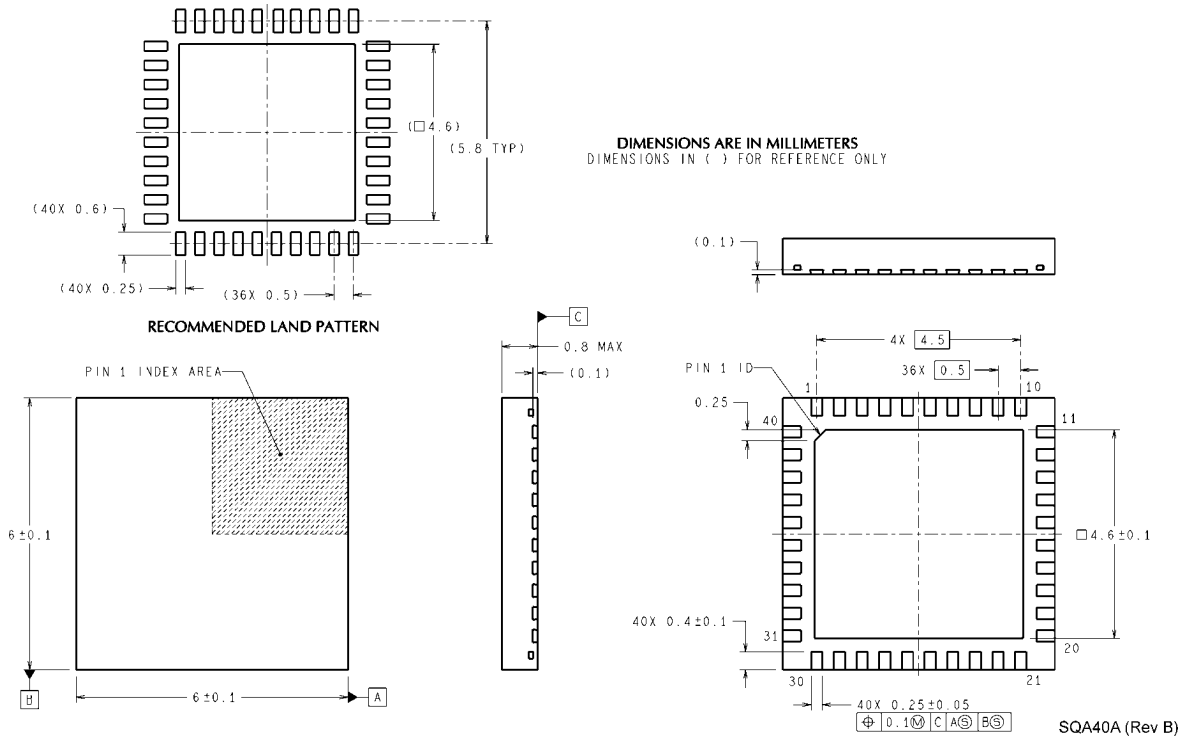
INTERCONNECT GUIDELINES

See AN-1108 and AN-905 for full details.

- Use 100Ω coupled differential pairs
- Use the S/2S/3S rule in spacings
  - S = space between the pair
  - 2S = space between pairs
  - 3S = space to LVCMOS signal
- Minimize the number of Vias

- Use differential connectors when operating above 500Mbps line speed
- Maintain balance of the traces
- Minimize skew within the pair

Additional general guidance can be found in the LVDS Owner's Manual - available in PDF format from the National web site at: **www.national.com/lvds**

Physical Dimensions inches (millimeters) unless otherwise noted

DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY

RECOMMENDED LAND PATTERN

PIN 1 INDEX AREA

DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY

SQA40A (Rev B)

DS90UR903Q Serializer
NS Package Number SQA40A

RECOMMENDED LAND PATTERN

PIN 1 INDEX AREA

SQA48A (Rev B)

DS90UR904Q Deserializer
NS Package Number SQA48A

Notes

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LVDS	www.national.com/lvds	Packaging	www.national.com/packaging
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero
Temperature Sensors	www.national.com/tempsensors	SolarMagic™	www.national.com/solarmagic
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